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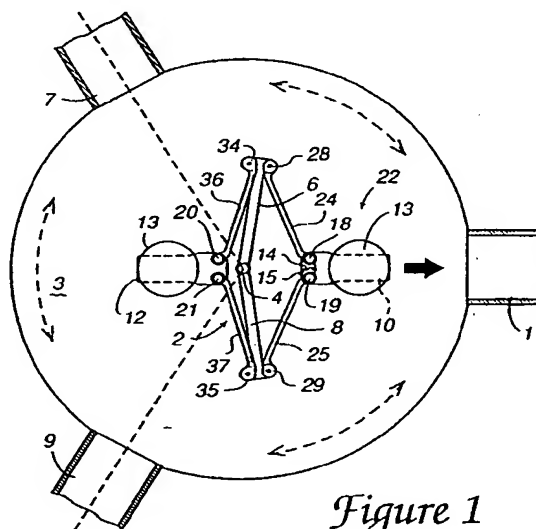
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**D-87712 Mindelheim (DE)**(54) **Robot assembly.**

(57) A robot assembly (2), including a central hub (4), has two arms (6, 8) arranged for independent rotation about the hub (4). Two carriers (10, 12), oriented 180° apart from each other, are coupled to an end of each of the arms (6, 8). A drive is provided for rotating the arms (6, 8) in opposite directions to extend one or the other of said carriers (10, 12) radially from said central hub (4), and for rotating the arms (6, 8) in the same direction to effect rotation of the carriers (10, 12).

*Figure 1***EP 0 567 121 A1**

## BACKGROUND OF THE INVENTION

### 1. TECHNICAL FIELD

The present invention relates to robotics. More particularly, the present invention relates to a robot assembly for the simultaneous manipulation of multiple objects, for example semiconductor wafers.

### 2. DESCRIPTION OF THE PRIOR ART

The use of robot arms is a well established manufacturing expedient in applications where human handling is inefficient and/or undesired. For example, in the semiconductor arts robot arms are used to handle wafers during various process steps. Such process steps include those which occur in a reaction chamber, e.g. etching, deposition, passivation, etc., where a sealed environment must be maintained to limit the likelihood of contamination and to ensure that various specific processing conditions are provided.

Current practice includes the use of robot arms to load semiconductor wafers from a loading port into various processing ports within a multiple chamber reaction system. The robot arm is then employed to retrieve the wafer from a particular port after processing within an associated process chamber. The wafer is then shuttled by the robot arm to a next port for additional processing. When all processing within the reaction system is complete, the robot arm returns the semiconductor wafer to the loading port and a next wafer is placed into the system by the robot arm for processing. Typically, a stack of several semiconductor wafers is handled in this manner during each process run.

In multiple chamber reaction systems it is desirable to have more than one semiconductor wafer in process at a time. In this way, the reaction system is used to obtain maximum throughput. In the art, a robot arm used in a reaction system must store one wafer, fetch and place another wafer, and then fetch and place the stored wafer. Although this improves use of the reaction system and provides improved throughput, the robot arm itself must go through significant repetitive motion.

One way to overcome the inefficiency attendant with such wasted motion is to provide a robot arm having the ability to handle two wafers at the same time. Thus, some equipment manufacturers have provided a robot arm in which the two carriers are rotated about a pivot by a motor with a belt drive at the end of the arm. In this way, one wafer may be stored on one carrier while the other carrier is used to fetch and place a second wafer. The carriers are then rotated and the stored wafer may be placed as desired. Such mechanism is rather complex and requires a massive arm assembly to

support the weight of a carrier drive located at the end of an extendible robot arm. For example, three drives are usually required for a system incorporating such a robot arm: one drive to rotate the arm, one drive to extend the arm, and one drive to rotate the carriers. Thus, any improvement in throughput as is provided by such a multiple carrier robot arm comes at a price of increased cost of manufacture, increased weight and power consumption, and increased complexity and, thus, reduced reliability and serviceability.

Another approach to providing a multiple carrier robot arm is to place two robot arms coaxially about a common pivot point. Each such robot arm operates independently of the other and improved throughput can be obtained through the increased handling capacity of the system, i.e. two arms are better than one. However, it is not simple to provide two robot arms for independent operation about a common axis. Thus, multiple drives and rigid shafts must be provided, again increasing the cost of manufacture and complexity while reducing reliability.

### SUMMARY OF THE INVENTION

The present invention is a robot assembly, including a central hub having two arms. Each arm is arranged for rotation relative to the hub. Two carriers, spaced apart from each other, are provided for handling various objects, such as semiconductor wafers. Each carrier is coupled to an end of each of the arms. A drive is provided for rotating the arms in opposite directions from each other to extend one or the other of the carriers radially from the central hub, and for rotating both arms in the same direction to effect rotation of the carriers about the hub. In the preferred embodiment, one drive is used for rotation of one arm and a second drive is used for rotation of the other arm. By synchronizing drive operation the arms can be rotated in the same or opposite directions.

### BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a plan view of a robot assembly according to the present invention;

Fig. 2 is a detailed plan view of a robot assembly according to the present invention;

Fig. 3 is a detailed plan view of a portion of a robot assembly according to an alternative embodiment of the invention; and

Figs. 4a, 4b, and 4c are schematic representations depicting operation of a robot assembly according to the present invention.

## DETAILED DESCRIPTION OF THE INVENTION

The present invention is best understood by referring to the Drawings in connection with review of this Description. The present invention is a robot assembly adapted to handle multiple objects. In the preferred embodiment, the invention finds application in a reaction system, as is used in the manufacture of semiconductors. For example, the present invention is useful for inserting and withdrawing wafers through a reaction chamber port.

The present invention allows two objects, such as semiconductor wafers, to be handled simultaneously for either insertion, withdrawal, or rotation, such that one wafer may be stored on the robot assembly while the other is placed. This unique feature allows increased throughput during wafer processing when contrasted with prior art robot assemblies which must go through an entire manipulation cycle to effect wafer storage. In this way, the reaction chamber is continuously used to process a wafer, i.e. there is no 'dead-time' while a processed wafer is replaced in the stack and a 'fresh' wafer is fetched, as with prior art systems. The present invention provides similar advantages when used in a daisy-chain type processing arrangement, i.e. multiple reaction chambers used sequentially for a series of processing steps.

In Fig. 1, a robot assembly 2 is shown in plan view in the context of a reaction system 3. The robot assembly 2 is arranged centrally within the reaction system 3 for movement of a semiconductor wafer 13 to and from the reaction chambers 7, 9, and 11. It should be noted that although the exemplary embodiment of the invention discloses a robot assembly centrally located within a reaction system, with the reaction system including three reaction chambers, the present invention is intended for many different applications. Thus, the exemplary embodiment should not be considered limiting the scope of the invention. That is, the present invention is readily adapted for use with any wafer handling application, including reaction systems having any number of reaction chambers and any sort of orientation for the robot assembly.

The robot assembly 2 includes a first arm 6 and a second arm 8 arranged such that one end of each arm is coupled to a central hub 4. Each arm may be rotated independently of the other arm in either a clockwise or a counter-clockwise fashion about hub 4. Thus, the arms may be rotated in both a similar and in an opposite direction. Rotation may be accomplished by any motive source, such as an electrically operated motor or motors.

The motive source should be configured to rotate arm 6 and arm 8 reversibly in either opposing directions or in the same direction. In the preferred embodiment of the invention, the arms

are rotatable independently and coaxially about the hub and the motive source is a magnetically coupled motor of the type described in EP 0 423 608 A1.

The arms 6/8 each include a pivot (28 and 29, respectively) provided at an end of the arm opposite the end coupled to hub 4. The arms are pivotally coupled to struts 24/25. The struts, in turn, are coupled by pivots 18/19, to a first wafer carrier 10. Each strut may include a meshing gear 14/15 at an end within the carrier 10 to maintain the carrier 10 in rigid radial alignment with the hub 4 as the struts are pivoted during operation of the robot assembly. In some embodiments of the invention a figure-eight belt may be substituted for the meshing gear 14/15, if desired.

The arms and linkage shown in Fig. 1 form a compound articulated mechanism which is sometimes referred to in the mechanical arts as a frog-leg mechanism. In Fig. 1, the carrier 10 is shown in a partially extended position, for example delivering or retrieving a wafer from a reaction chamber.

A second wafer carrier 12 is also shown in Fig. 1, in which arms 6/8 are joined to struts 36/37 at pivots 34/35 located at one end of the struts. The struts 36/37 are also joined at pivots 20/21, located at the other end of the struts, to the carrier 12. As discussed more fully below, the carrier 12 is linked to the arms 6/8 in an identical manner to that for the carrier 10, such that the two carriers are maintained 180° apart from each other about the axis of the hub 4.

Fig. 2 is a detailed top plan view of robot assembly 2 showing one carrier 10 in a partially extended position and another carrier 12 in a partially retracted position. Arrows in the Fig. show relative motion of arms 6 and 8 about the hub 4. The carrier 10 is coupled to the arms 6/8 by the struts 24/25. The struts 24/25 are configured for rotation in concert with the arms 6/8 by operation of pivots 18/19 at the carrier 10 and pivots 28/29 at the arms 6/8.

The carrier 12 is pivotably coupled to struts 36/37 at pivots 20/21. Struts 36/37 are in turn pivotably coupled to the arms 6/8 at pivots 34/35.

It should be noted that, although the arms 6/8 are each shown having two pivots, one for each carrier/strut, the arms could readily be configured such that the carriers/struts share a single pivot point on each arm. Such arrangement is shown in Fig. 3, in which arms 6/8 are arranged to pivot about the hub 4 at one end of the arms. The other end of each arm includes a single pivot point 40/42, respectively. The arms are coupled at the pivots points 40/42 to two struts each, one strut for each carrier. Thus, the arm 6 is coupled to one strut 24 (for carrier 10) and to another strut 36 (for carrier 12) at pivot 40. While the arm 8 is coupled

to one strut 22 (for carrier 10) and to another strut 37 at pivot 42.

Operation of the present invention is shown in Figs. 4a, 4b, and 4c. In Fig. 4a, the robot assembly 2 is shown undergoing rotational motion of both carriers 10/12 simultaneously about the hub 4, as is indicated by the arrow in the Fig. In preparation for this rotational motion, the arms 6/8 are independently rotated clockwise or counterclockwise about the hub 4 until they are 180° apart, at which point the carriers 10/12 are equidistant from the hub 4. Rotation of the carriers is then effected by rotating both arms 6/8 in the same direction, e.g. clockwise. This rotational force is coupled to the carriers 10/12 through associated struts 24/25 and 36/37.

Fig. 4b shows operation of the robot assembly in which the first carrier 10 is retracted and the second carrier 12 is extended. As is indicated by the arrows, respective counter-clockwise/clockwise motion of the arms 6/8 about the hub 4 exerts a pulling force on the struts 24/25, drawing one carrier 10 toward the hub 4. At the same time, the arms 6/8 exert a pushing force on the struts 36/37 forcing the other carrier 12 away from the hub 4.

Fig. 4c shows operation of the robot assembly in which second carrier 12 is retracted and the first carrier 10 is extended. As is indicated by the arrows, respective clockwise/counter-clockwise motion of the arms 6/8 about the hub 4 exerts a pulling force on the struts 36/37, drawing one carrier 12 toward the hub 4. At the same time, the arms 6/8 exert a pushing force on the struts 24/25 forcing the other carrier 10 away from the hub 4.

The present invention is useful for manipulating multiple objects. As described above, a preferred embodiment of the invention finds application in a reaction system for processing semiconductor wafers. In Fig. 1, a carrier 10 is shown in an extended position, while the other carrier 12 is shown in a retracted position. Thus, one carrier 12 may be used to store a semiconductor wafer, while a carrier 10 is, for example, withdrawing a semiconductor wafer 13 from a reaction chamber 11.

In operation, the robot arm fetches a wafer from a stack of wafers and places the wafer in a reaction chamber. The robot arm then fetches a second wafer while the first wafer remains in the reaction chamber. After sufficient processing time has elapsed, the first wafer is withdrawn from the reaction chamber and the robot arm now carries two wafers, one processed and one fresh. The carriers, when positioned as shown in Fig. 4a, are then rotated, such that a fresh wafer on one carrier is placed into the reaction chamber, while a processed wafer on the other carrier is returned to the stack of wafers. The robot arm then loads another fresh wafer from the stack of wafers and returns to the reaction chamber. The process just described

is repeated as required. Additionally, the robot arm of the present invention is readily adapted for use in daisy-chain processes where wafers are moved sequentially through a series of reaction chambers as part of a process flow.

In contrast, prior art robot assemblies require that, for the operation described above, a first wafer is removed from the reaction chamber by the robot assembly and returned to a stack of wafers for storage. The robot assembly is then used to fetch a second wafer and place it in a reaction chamber. During the interval between storage of the first wafer and placing a the second wafer into the reaction chamber, the reaction chamber is idle. This deadtime seriously degrades throughput in the reaction system. The present invention therefore reduces handling and the number of steps involved in moving a wafer within a reaction system and replacing the wafer with a fresh wafer, thus increasing throughput (by eliminating unnecessary and wasted robot assembly motion).

Although the invention is described herein with reference to the preferred embodiment of the robot assembly, one skilled in the art will readily appreciate that applications, other than those involving the handling of semiconductor wafers in a reaction system, and other manipulation schedules, and geometries, etc. may be substituted for those set forth herein without departing from the spirit and scope of the present invention. For example, it is not necessary to have independent coaxial motion of the arms about the hub. Rather, various motions may be provided without departing from the spirit and scope of the invention. Accordingly, the invention should only be limited by the Claims included below.

## Claims

1. A robot assembly, comprising:
  - a central hub (4);
  - two arms (6, 8) arranged for rotation relative to said hub (4);
  - two carriers (10, 12), oriented 180° apart from each other, each carrier coupled to an end of each of said arms (6, 8); and
  - a drive for rotating the arms (6, 8) in opposite directions to extend one or the other of said carriers (10, 12) radially from said central hub (4), and for rotating the arms (6, 8) in the same direction to effect coaxial rotation of the carriers (10, 12).
2. The robot assembly of claim 1, further comprising:
  - an articulated linkage (24, 25, 36, 37) coupling said arms (6, 8) to said carriers (10, 12).

3. The robot assembly of claim 1 or 2,  
wherein said drive comprises a magnetically  
coupled motor.
4. A robot assembly, comprising:
  - a central hub (4);
  - a first arm (6) coupled to said hub (4) at an  
end of said first arm (6) for coaxial rotation  
about said hub (4);
  - a second arm (8) coupled to said hub (4)  
at an end of said second arm (8) for coaxial  
rotation about said hub (4);
  - two carriers (10, 12) oriented 180° apart  
from each other;
  - a compound articulated linkage (24, 25,  
36, 37) for coupling each carrier to an end of  
each of said arms (6, 8); and
  - a drive for rotating the arms (6, 8) in  
opposite directions to extend one or the other  
of said carriers (10, 12) radially from said cen-  
tral hub (4), and for rotating the arms (6, 8) in  
the same direction to effect rotation of the  
carriers (10, 12).
5. The robot assembly of claim 4,  
wherein said drive comprises a magnetically  
coupled motive source.
6. The robot assembly of any of the preceding  
claims,  
wherein said carriers (10, 12) are adapted for  
manipulating semiconductor wafers.
7. In a reaction system for processing semicon-  
ductor wafers, a robot assembly, comprising:
  - a central hub (4);
  - a first arm (6) coupled to said hub (4) at an  
end of said first arm (6) for coaxial rotation  
about said hub (4);
  - a second arm (8) coupled to said hub (4)  
at an end of said second arm (8) for coaxial  
rotation about said hub (4);
  - two carriers (10, 12) oriented 180° apart  
from each other;
  - a first articulated linkage (24, 25) for cou-  
pling one carrier (10) to an end of each of said  
arms (6, 8);
  - a second articulated linkage (36, 37) for  
coupling the other carrier (12) to an end of  
each of said arms (6, 8); and
  - a drive for independent rotation of the  
arms (6, 8) in opposite directions about the  
axis of the hub (4) to extend one of said  
carriers (10, 12) radially from said central hub  
(4) while drawing the other of said carriers (10,  
12) toward the hub (4), and for rotation of the  
arms (6, 8) in the same direction to effect  
rotation of the carriers (10, 12).
8. The robot assembly of claim 7,  
wherein said drive comprises magnetically  
coupled motors.
9. The robot assembly of any of the preceding  
claims, wherein said articulated linkage further  
comprises:
  - a meshing mechanism (14, 15), whereby  
said carriers (10, 12) are maintained in radial  
alignment with said hub (4).

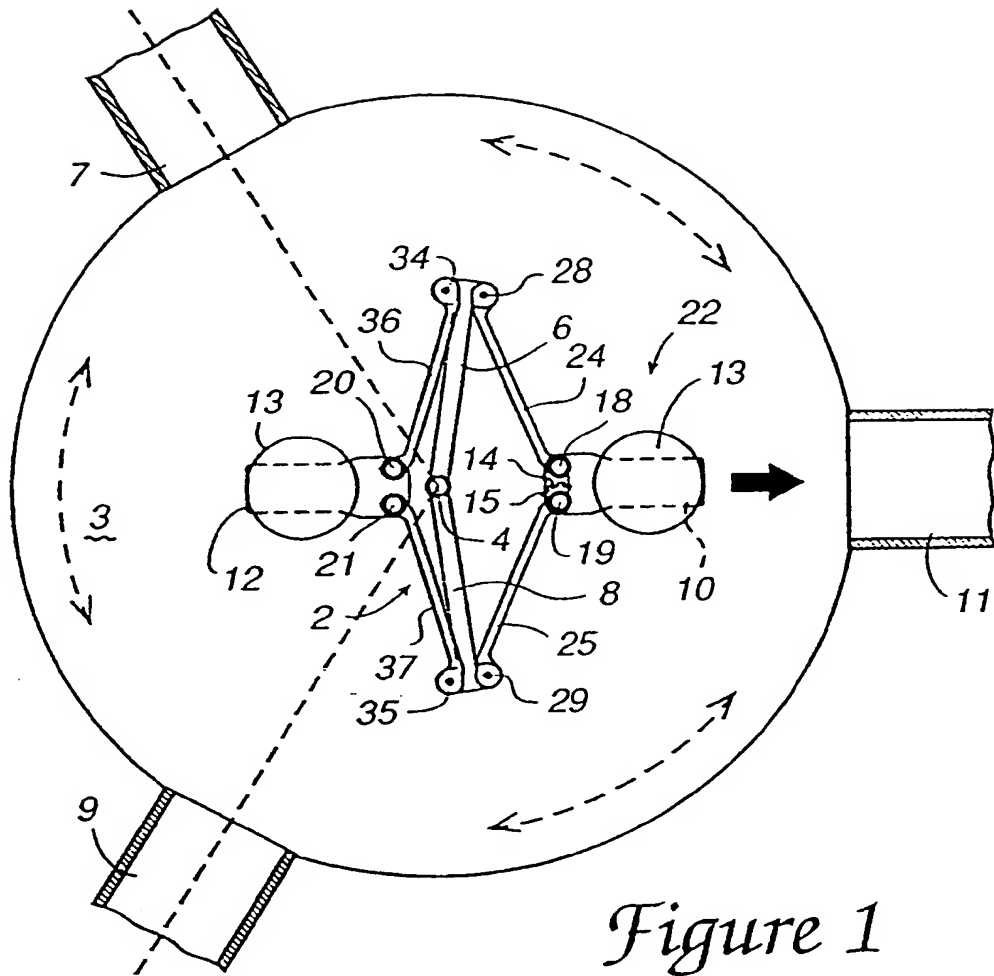


Figure 1

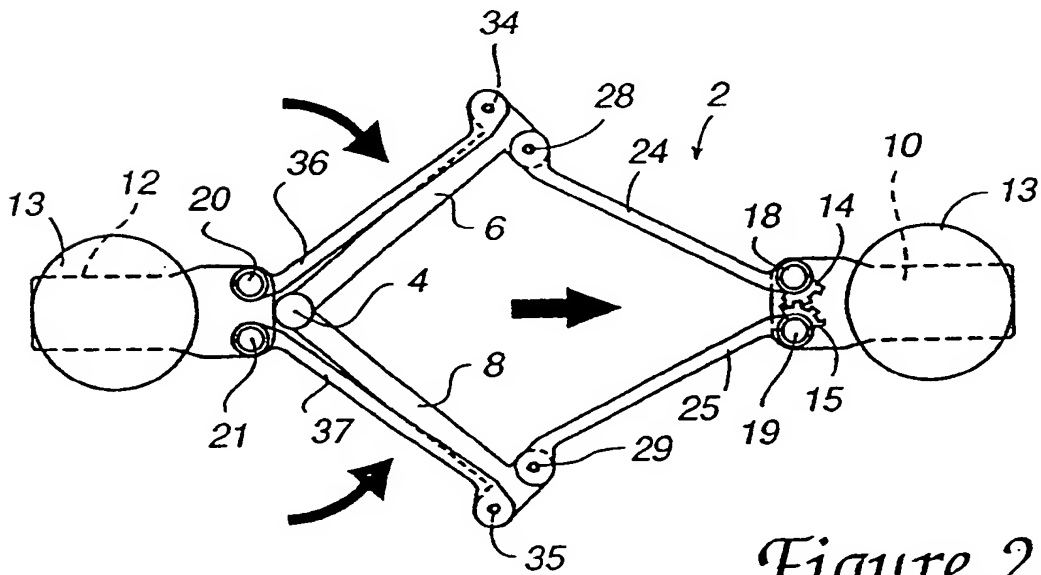
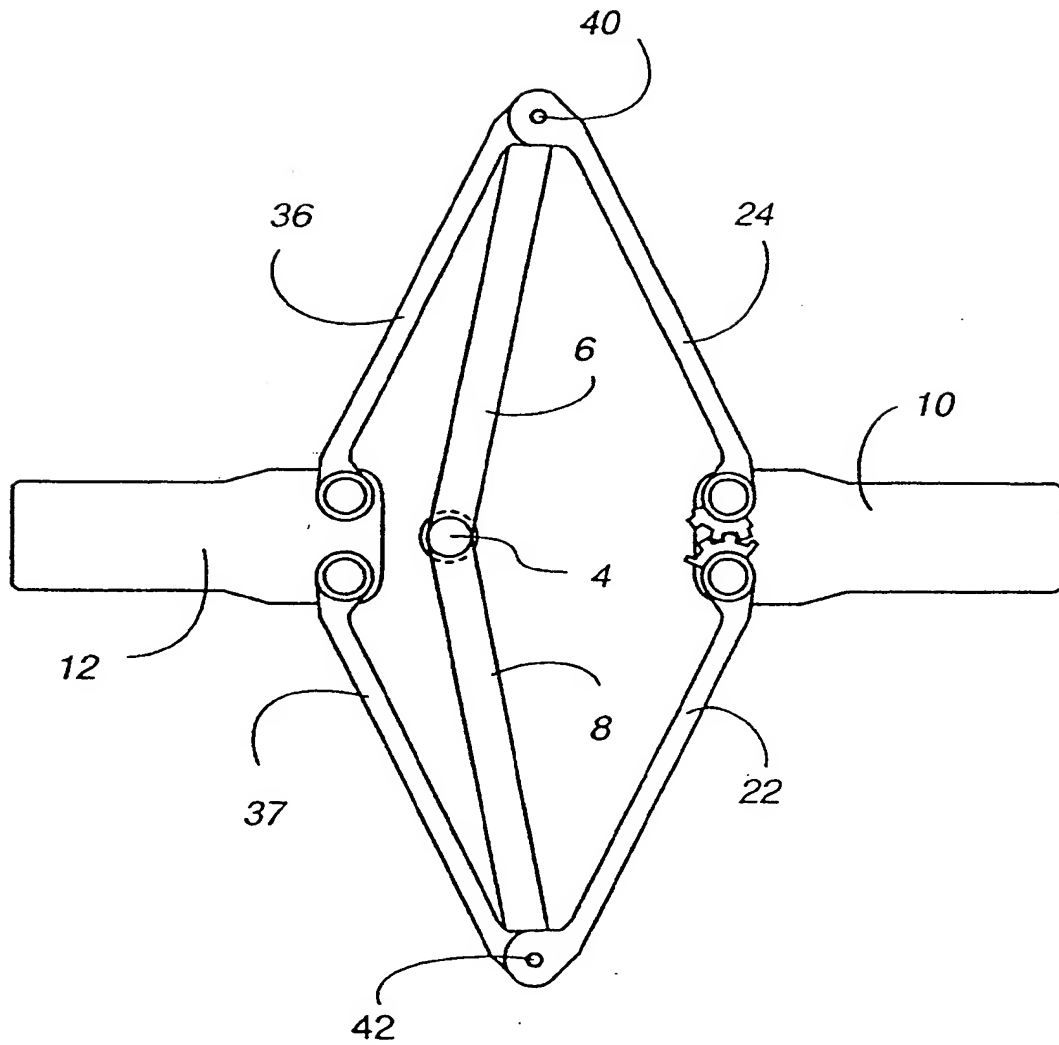
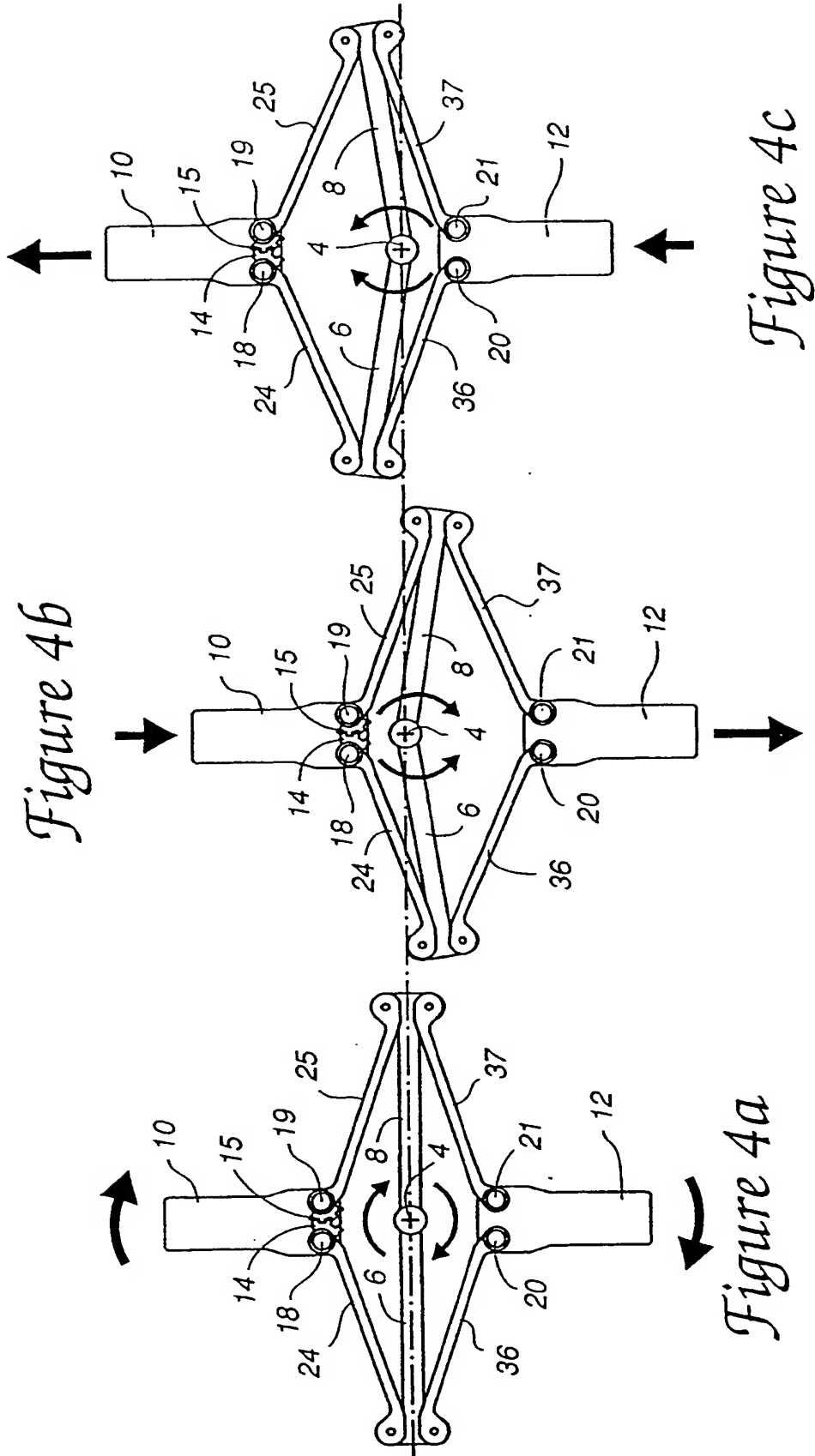


Figure 2



*Figure 3*







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## EUROPEAN SEARCH REPORT

Application Number

EP 93 10 6555

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int. Cl.5)
Y	EP-A-0 066 014 (COMAU) * page 3, line 15 - page 5, line 20 *	1-3	B25J9/10
A	---	4,7	
Y,D	EP-A-0 423 608 (APPLIED MATERIALS) * column 8, line 43 - column 9, line 9; claims 1,7-9 *	1-3	
A	---	4-8	
X,P	DE-U-9 200 071 (G + W BUHLER MASCHINENBAU) * page 14, line 11 - line 16 * * page 15, line 6 - line 27 *	1,2	
A,P	---	4,7,9	
A	EP-A-0 160 305 (TOKUDA) * page 5, line 8 - page 7, line 13 *	1,9	
			TECHNICAL FIELDS SEARCHED (Int. Cl.5)
			B25J
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 07 JULY 1993	Examiner LAMMINEUR P.C.G.
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X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document		T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons A : member of the same patent family, corresponding document	

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